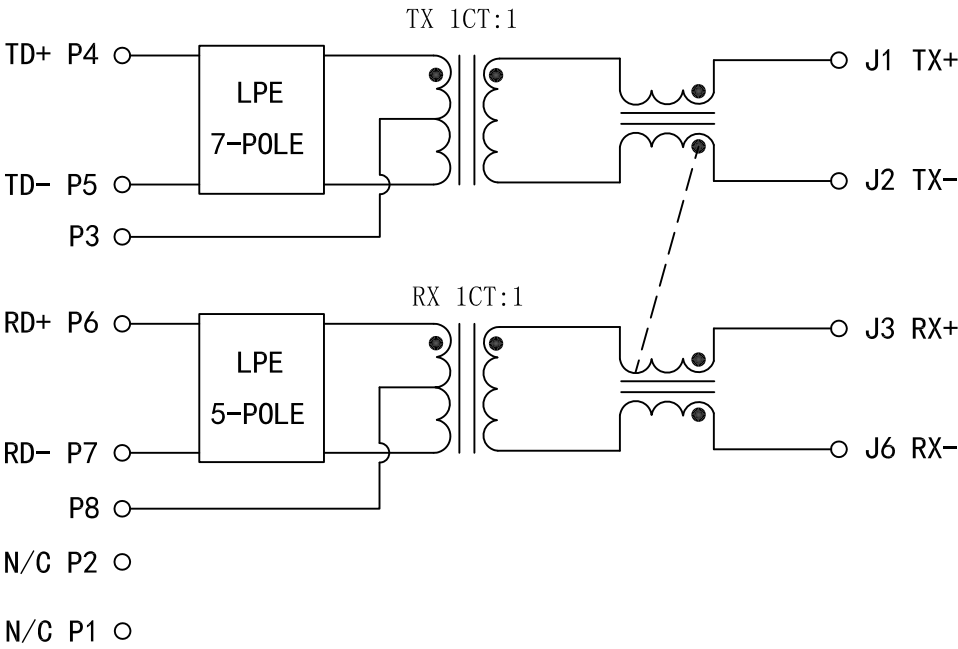


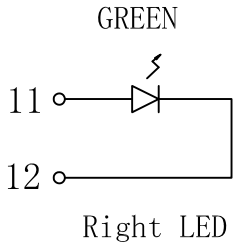
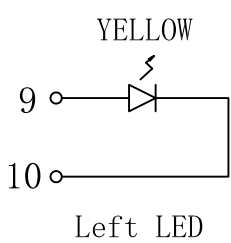
Schematic:

REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2010/05/12	



Electrical Specifications: @25℃

- 1. Turns Ratio:
TX=1CT:1 RX=1CT:1
- 2. Return Loss:
5~10MHz:-15dB MIN
- 3. Crosstalk:
1~10MHz:-30dB MIN
- 4. Insertion Loss:
5~10MHz:-1dB MAX
- 5. Attenuation: @30MHz
TX:-30dB MIN
RX:-18dB MIN
- 6. Primary Impedance:
TX: 100Ω RX:100Ω
- 7. Isolation Voltage: 1500Vrms
- 8. Operating Temp: 0℃~70℃.

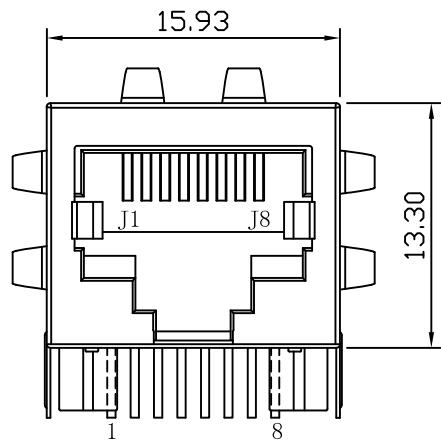


Emitting Color	λ p(nm)	VF@IF=20mA	IR @VR=5V
GREEN	565	1.8~2.6V	10 μ A max
YELLOW	585	1.8~2.6V	10 μ A max

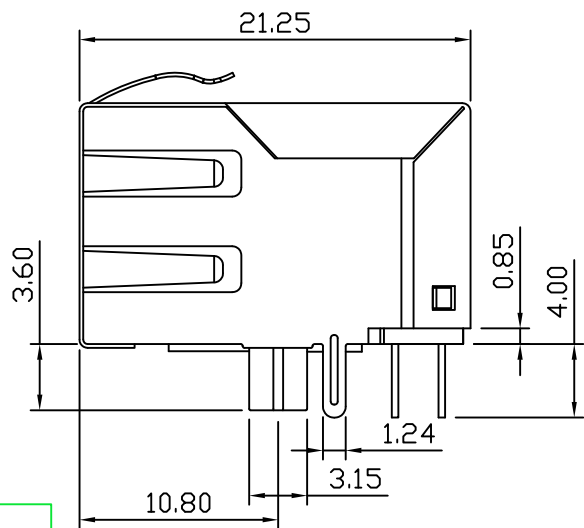
X:X ±0.30	APPD:	LINK-PP INT'L TECHNOLOGY CO., LIMITED		
X:XX ±0.25	CHKD:			
X:XXX ±0.05	DR: TOM	TITLE: RJ45 Connector With 10 Base-TX Integrated Magnetics		
ANGLES ±1°	UNIT: mm	PART NO.: LPJ0215CNL		
	SCALE: 2/1	SHEET: 1/2	REV: A	DWG NO.: LP09011428

Mechanical:

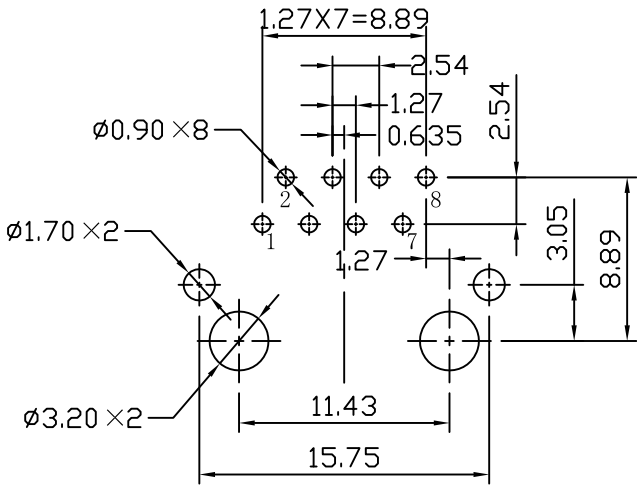
REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2010/05/12	



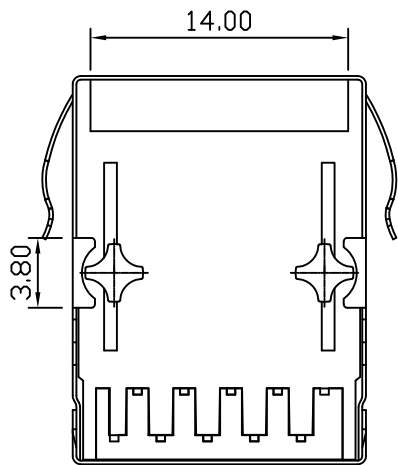
Front Side View



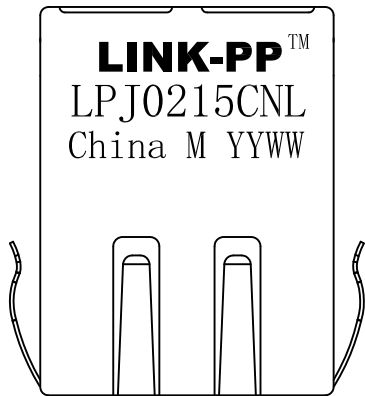
Left Side View



Suggested PCB Layout (Top View)



Bottom Side View



Top Side View

NOTES:

1. Designed to support application, such as SOHO (ADSL modems), LAN-on-Motherboard (LOM), hub and Switches.
2. Meets IEEE 802.3 specification
3. Connector Materials:
Housing: Thermoplastic PBT+30%G.F UL94V-0
Contact: Phosphor Bronze C5210R-EH Thickness=0.35mm
Pins: Brass C2680R-H Thickness=0.35mm
Shield: SUS 201-1/2H Thickness=0.2mm
Contact plating: Gold 6 micro-inches min. In contact area.
4. Wave solder tip temperature: 265°C Max, 5 Sec.
5. UL Certification: File Number E484635

X:X ±0.30	APPD:	LINK-PP INT'L TECHNOLOGY CO., LIMITED		
X:XX ±0.25	CHKD:			
X:XXX ±0.05	DR: TOM	TITLE: RJ45 Connector With 10 Base-TX Integrated Magnetics		
ANGLES ±1°	UNIT: mm	PART NO.: LPJ0215CNL		
	SCALE: 2/1	SHEET: 2/2	REV: A	DWG NO.: LP09011428